

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3527052

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	ANDRES SEVTSUK	03/17/2014
	RAUL KALVO	03/17/2014
RECEIVING PARTY DATA		
Name:	SINGAPORE UNIVERSITY OF TECHNOLOGY AND DESIGN	
Street Address:	20 DOVER DRIVE	
City:	SINGAPORE	
State/Country:	SINGAPORE	
Postal Code:	138682	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14777244
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	47707	
NAME OF SUBMITTER:	KAMERON D. KELLY	
SIGNATURE:	/Kameron D. Kelly/	
DATE SIGNED:	09/15/2015	
Total Attachments: 3		
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DEED OF ASSIGNMENT

THIS DEED made the 17th day of March two thousand and fourteen (2014)
BETWEEN,

(1) SEVTSUK, Andres of
76 Guan Chuan Street
#02-04
Singapore 160076

(2) KALVO, Raul of
Pearlbank 1
#37-03
Singapore 169016

[hereinafter referred to as "the Assignors"]

AND

(1) Singapore University of Technology and Design
20 Dover Drive
Singapore 138682

[hereinafter referred to as "the Assignee"]

WHEREAS the Assignors warrant that the Assignors are the inventors of an invention relating to an invention entitled "**Grid Structure**" [hereinafter referred to as "the Invention"], the subject of International Patent Application No. **PCT/SG2014/000132**, including the designation of the United States of America [hereinafter referred to as "the Application"]

AND WHEREAS the Assignors have agreed to assign to the Assignee and the Assignee desires to take assignment of all rights, title and interest of the Assignors in and to the Invention and the Application,

NOW THIS DEED WITNESSETH

1. In consideration of the sum of one dollar (\$1) and other good and valuable consideration receipt of which is hereby acknowledged by the Assignors, the Assignors hereby assign to the Assignee all of his rights, title and interest in and to the Invention and the Application including:

- (a) all rights and powers to make one or more applications for Letters Patent or other form of protection in the name of the Assignee in Singapore, the United States of America and in any other country of the world in respect of the Invention, and all

rights, title and interest in and to any Letters Patent or other form of protection to mature from any such application,

- (b) the rights and powers to prosecute the Application and all rights, title and interest in and to any Patent or Patents granted thereon together with any extension of the term of any such Patent or Patents as may be granted, SAVE THAT nothing in this Deed shall prevent the filing or proceeding of an Application to which this Deed relates, in the name of the Assignors or Inventors where such filing or proceeding of such Application is beneficial to the interests of the Assignee
- (c) the rights and powers to seek protection in countries other than Singapore by way of Patent, Petty Patent, Utility Model, Design Patent or other appropriate form of protection for the Invention, by way of application(s) for such protection made to the appropriate authorities in such other country or countries as the Assignee in its complete discretion may elect, whether or not any such foreign application(s) be made claiming International Convention priority from the Application hereby assigned
- (d) any Copyright owned by the Assignors in and to any drawings relating to the subject matter of the Invention together with the rights and powers such as subsist at the date of this Deed
- (e) to apply for registration of Copyright, Design, Design-Patent or like protection in the name of the Assignee in Singapore and in any other country of the world in respect of the subject matter of the said drawings and to any registration of Copyright, Design-Patent or like protection which matures from any such application, together with the rights to sue in respect of any infringement of that Copyright which may have occurred before the date of this Deed

2. The Assignors agree, at the expense of the Assignee, to sign, execute and deliver all documents, forms and papers reasonably required to be produced or obtained by the Assignee in connection with any application for Letters Patent or other form of protection for the subject matter of the Invention, in Singapore or elsewhere.

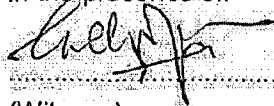
IN WITNESS WHEREOF the Assignors and Assignee executed this Deed the day and year first hereinbefore written.

ASSIGNORS

SIGNED, SEALED and DELIVERED

By the said **SEVTSUK, Andres**

in the presence of:



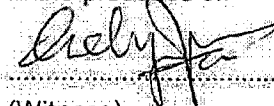
(Witness)



SIGNED, SEALED and DELIVERED

By the said **KALVO, Raul**

in the presence of:



(Witness)

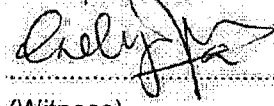


ASSIGNEE

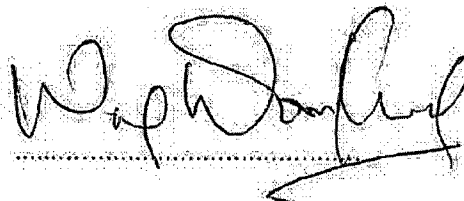
FOR AND ON BEHALF OF

By the said **Singapore University
of Technology and Design**

in the presence of:



(Witness)



Wong Woon Kwong

Director, Research and Industry Collaborations
Singapore University of Technology and Design

Evelyn Tan

Assistant Director, Research & Industry Collaborations
Singapore University of Technology and Design